

THE CLASSIC

PATENT DATE

SCANNED

54. 7-46

2

EXAMINER

APPLICANTS

37411

Process for etching vias in organosilicate glass materials without causing rie lag

PTO-2040
12/89

PREPARED AND APPROVED FOR ISSUE

ISSUING CLASSIFICATION

ORIGINAL		CROSS REFERENCE(S)					
CLASS	SUBCLASS	CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)				
INTERNATIONAL CLASSIFICATION							

☐ Continued on Issue Slip Inside File Jacket

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**TERMINAL
DISCLAIMER**

DRAWINGS

Sheets Drwg.

Figs. Drwg.

Print File

CLAIMS ALLOWED

Total Claims

Print Claim for O.G.

☐ a) The term of this patent subsequent to _____ (date) has been disclaimed.

☐ b) The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____

☐ c) The terminal months of this patent have been disclaimed.

(Assistant Examiner)

(Date)

(Primary Examiner)

(Date)

(Legal Instruments Examiner)

100

NOTICE OF ALLOWANCE MAILED

ISSUE FEE

Amount Due

Date Paid

ISSUE BATCH NUMBER

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(Rev. 6/98)

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